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(12) **United States Design Patent** (10) **Patent No.:** **US D813,410 S**  
**LiCalzi et al.** (45) **Date of Patent:** **\*\* Mar. 20, 2018**

(54) **SYSTEM INCLUDING MULTIPLE INSTRUMENT MODULES AND ARRANGEMENT THEREOF**

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(71) Applicant: **Siemens Healthcare Diagnostics Inc.**, Tarrytown, NY (US)

(57) **CLAIM**

The ornamental design for an system including multiple instrument modules and arrangement thereof, as shown and described.

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**DESCRIPTION**

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FIG. 1 is a front perspective view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;  
FIG. 2 is a rear perspective view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;  
FIG. 3 is a front elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;  
FIG. 4 is a rear elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;  
FIG. 5 is a left side elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;  
FIG. 6 is a right side elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;  
FIG. 7 is a top view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment; and,  
FIG. 8 is a bottom view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment.

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/569,391**

(22) Filed: **Jun. 27, 2016**

(51) **LOC (11) Cl.** ..... **24-01**

(52) **U.S. Cl.**  
USPC ..... **D24/216**

(58) **Field of Classification Search**  
USPC ..... D24/216, 111, 127, 107, 169, 186, 217, D24/219, 223–224, 231–234; D10/46,  
(Continued)

(56) **References Cited**

U.S. PATENT DOCUMENTS

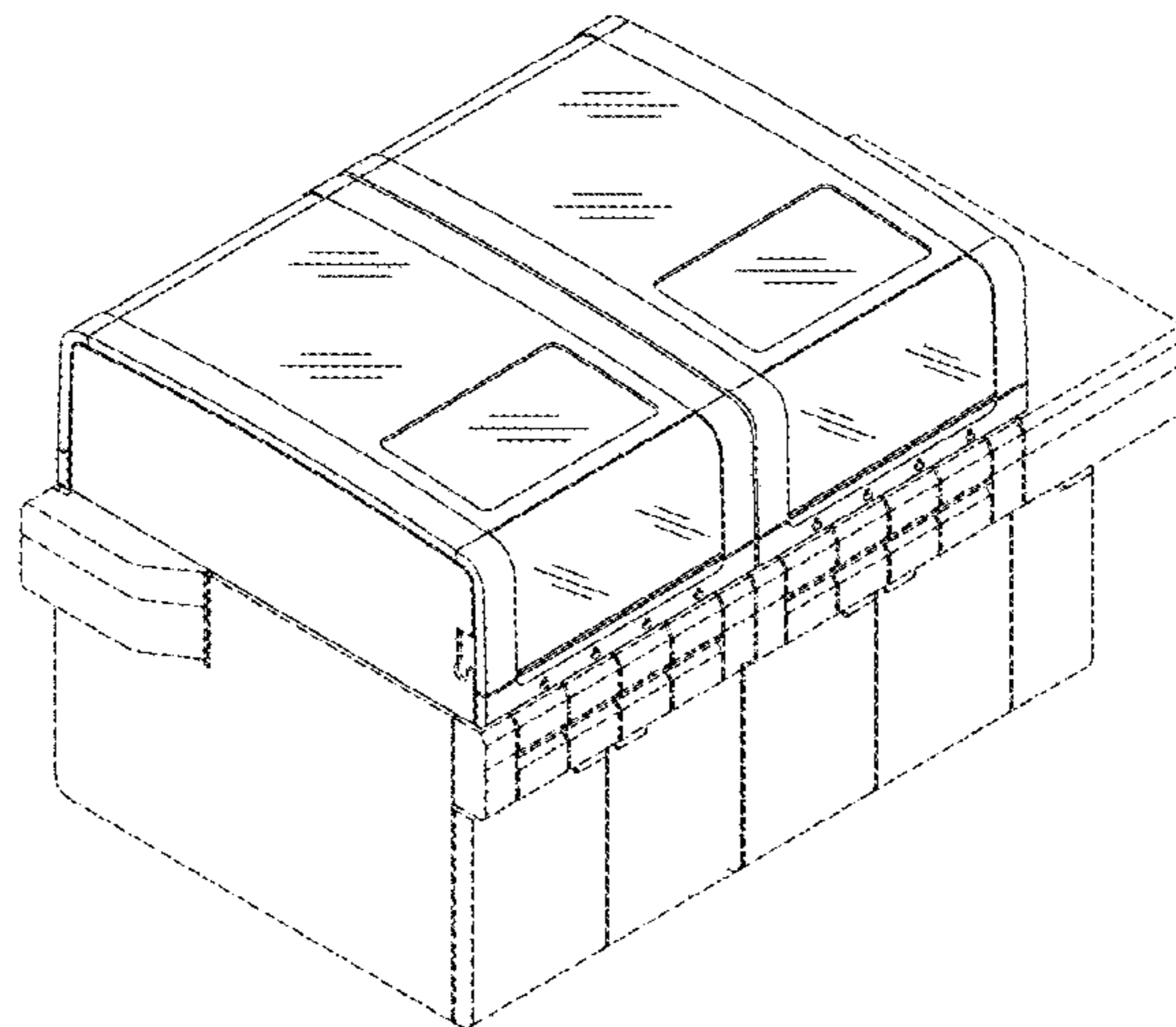
D645,367 S \* 9/2011 Hayashi ..... D10/81  
D669,189 S \* 10/2012 Liu ..... D24/216  
(Continued)

FOREIGN PATENT DOCUMENTS

JP 1517914 S 2/2015  
WO DM/081998 4/2014

The broken lines shown in the figures represent portions of the system including multiple instrument modules and arrangement thereof that form no part of the claimed design. The broken line showing immediately adjacent the shaded areas represents boundaries to the claimed design and forms no part of the claimed design.

**1 Claim, 8 Drawing Sheets**



(58) **Field of Classification Search**

USPC ..... D10/70, 81, 97; 422/1, 62-65, 67, 68.1,  
422/70, 81, 129, 500, 506, 561,  
422/FOR. 106; 435/287.1, 287.3;  
436/43, 45, 47; 600/300, 301, 368, 372,  
600/481, 529, 544, 554, 561; 607/4, 5, 9,  
607/30

CPC ... G01R 31/31907; B04B 13/00; B04B 15/00;  
B04B 2005/0435; B04B 5/0421; A61B  
5/157; G06F 19/366; B01D 21/262

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D676,143 S *	2/2013	Liu .....	D24/216
D676,568 S *	2/2013	Liu .....	D24/216
D685,483 S *	7/2013	LiCalzi .....	D24/216
D735,878 S *	8/2015	Chang .....	D24/216
D736,402 S	8/2015	Gutmann et al.	
D738,243 S *	9/2015	Selberg .....	D10/81

\* cited by examiner

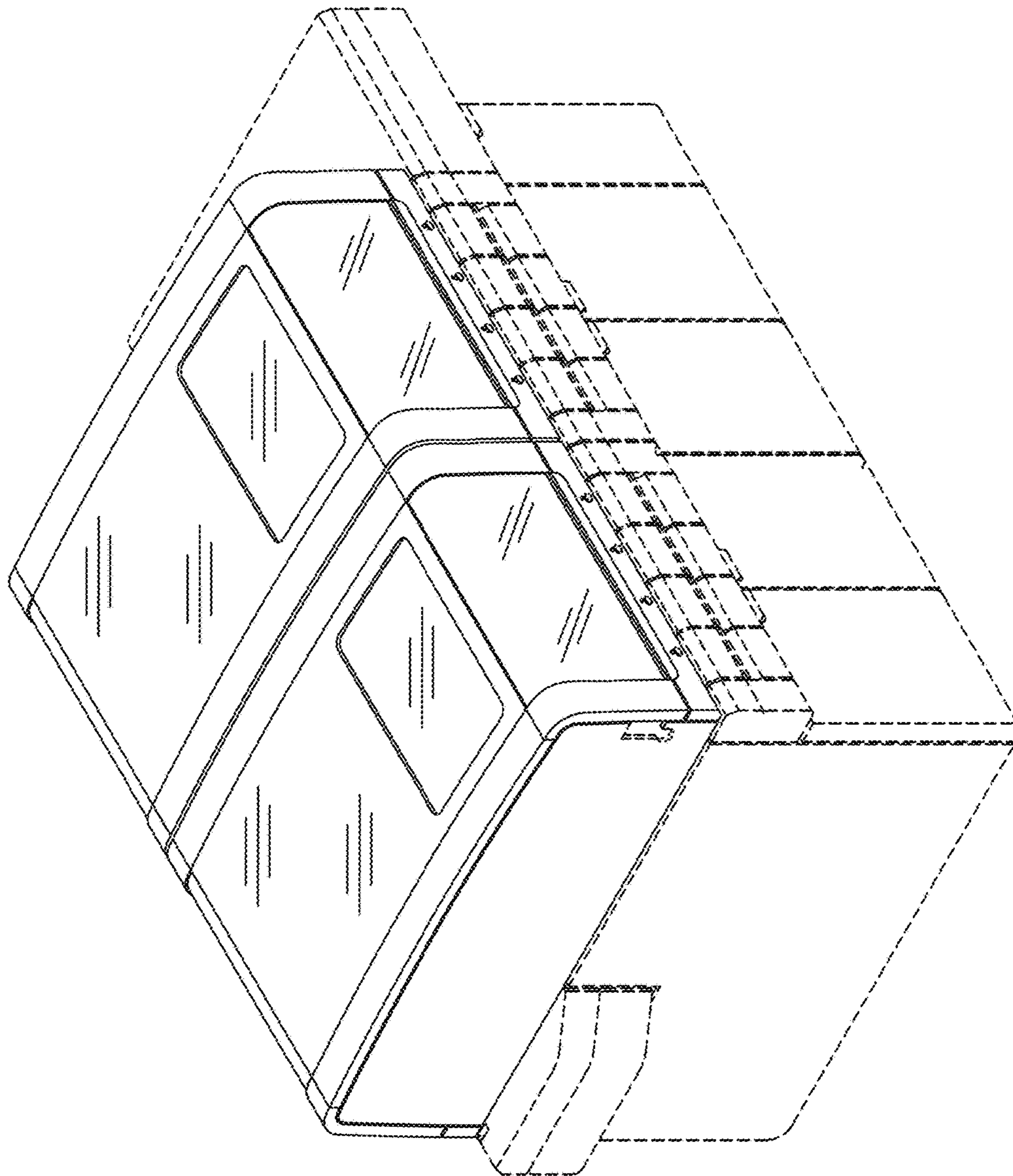


FIG. 1

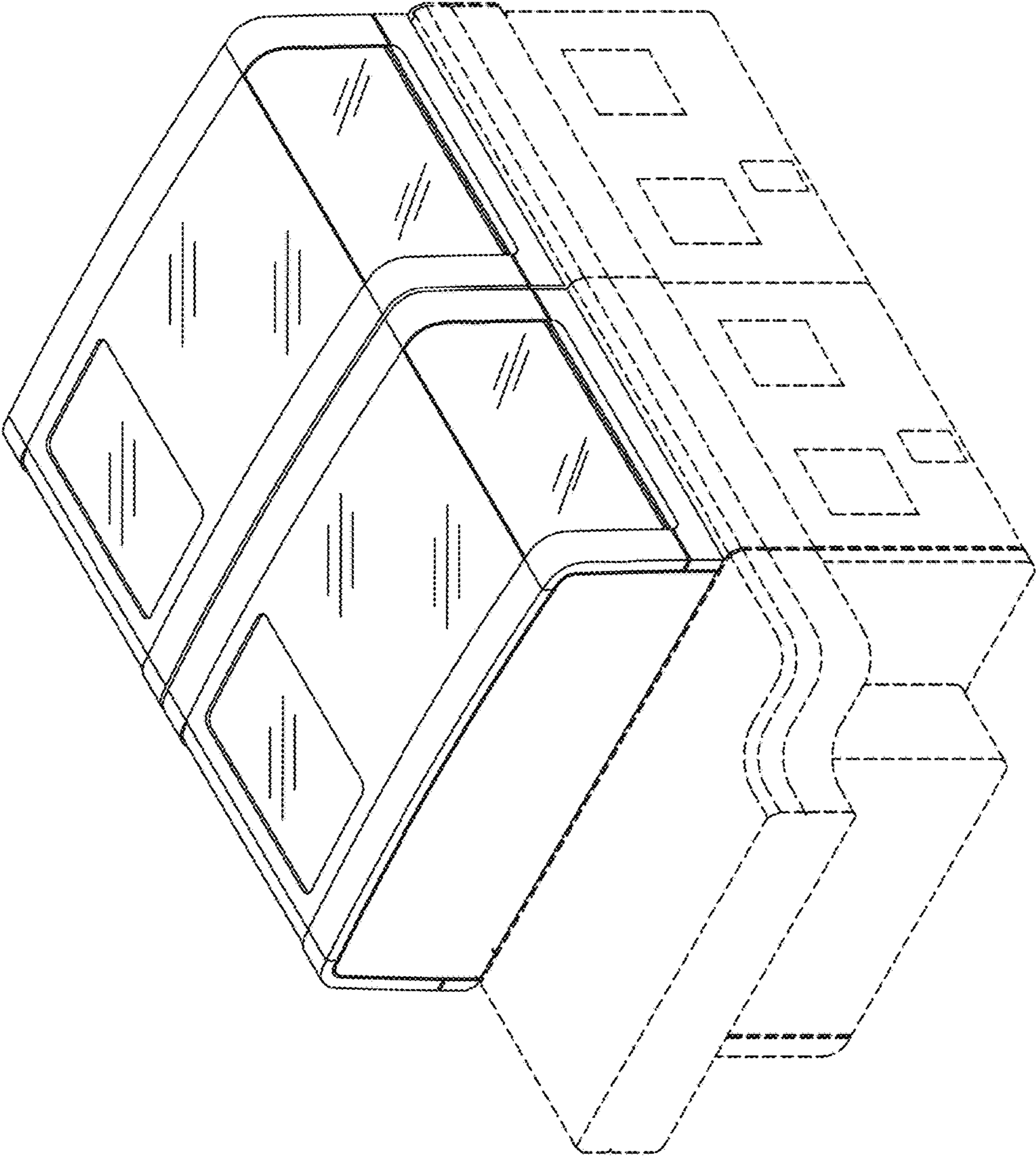


FIG. 2

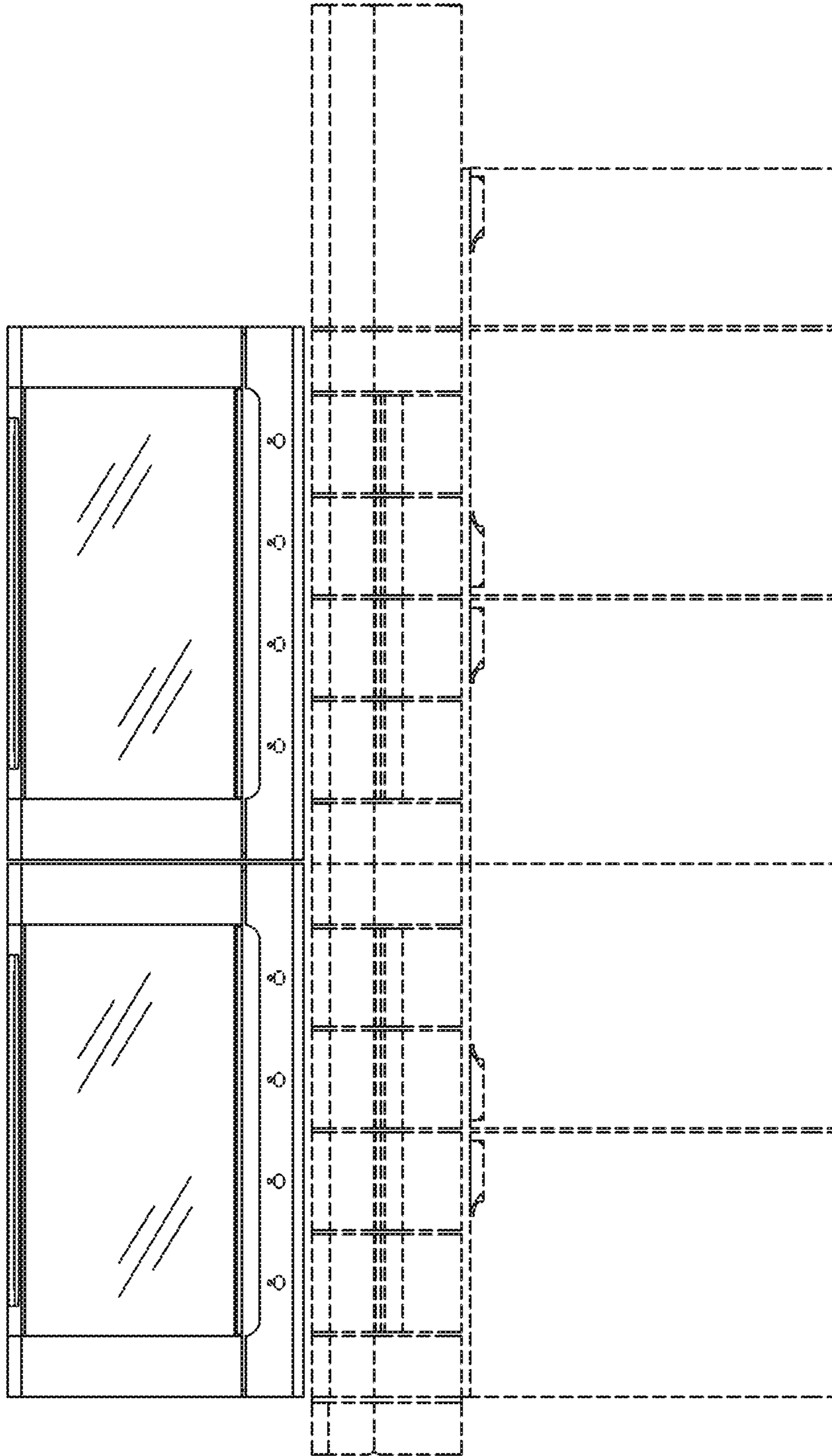


FIG. 3

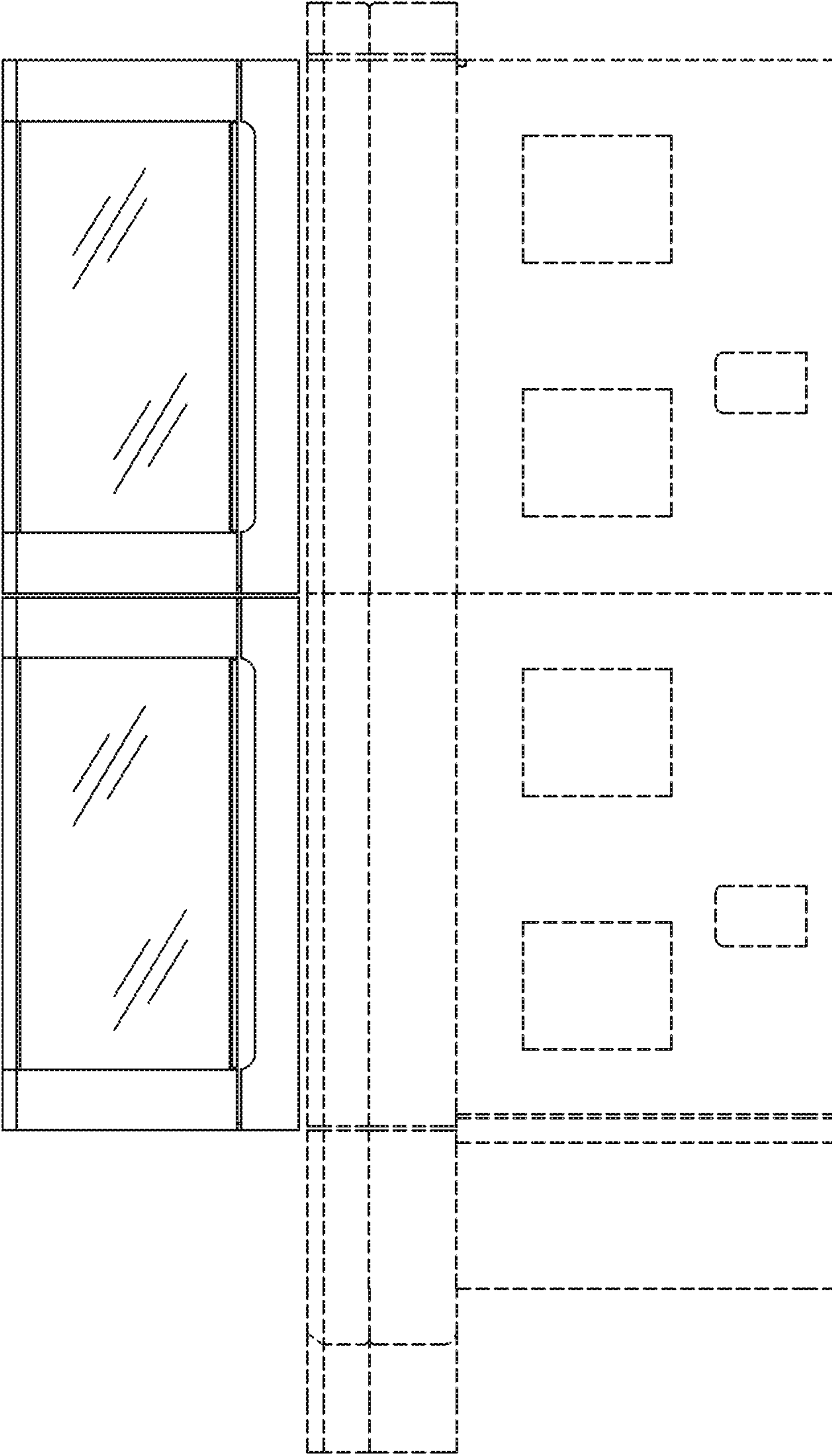


FIG. 4

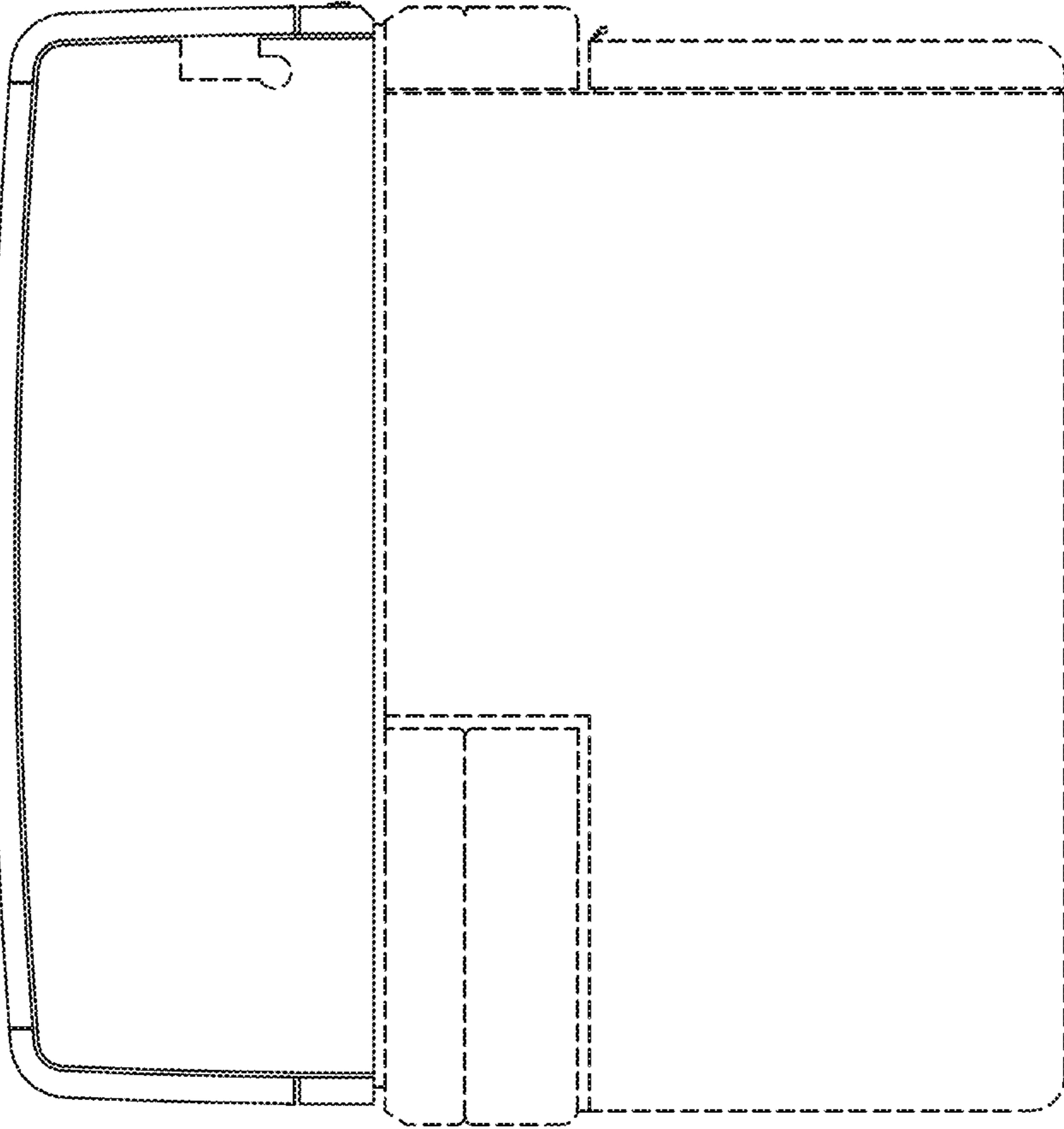


FIG. 5

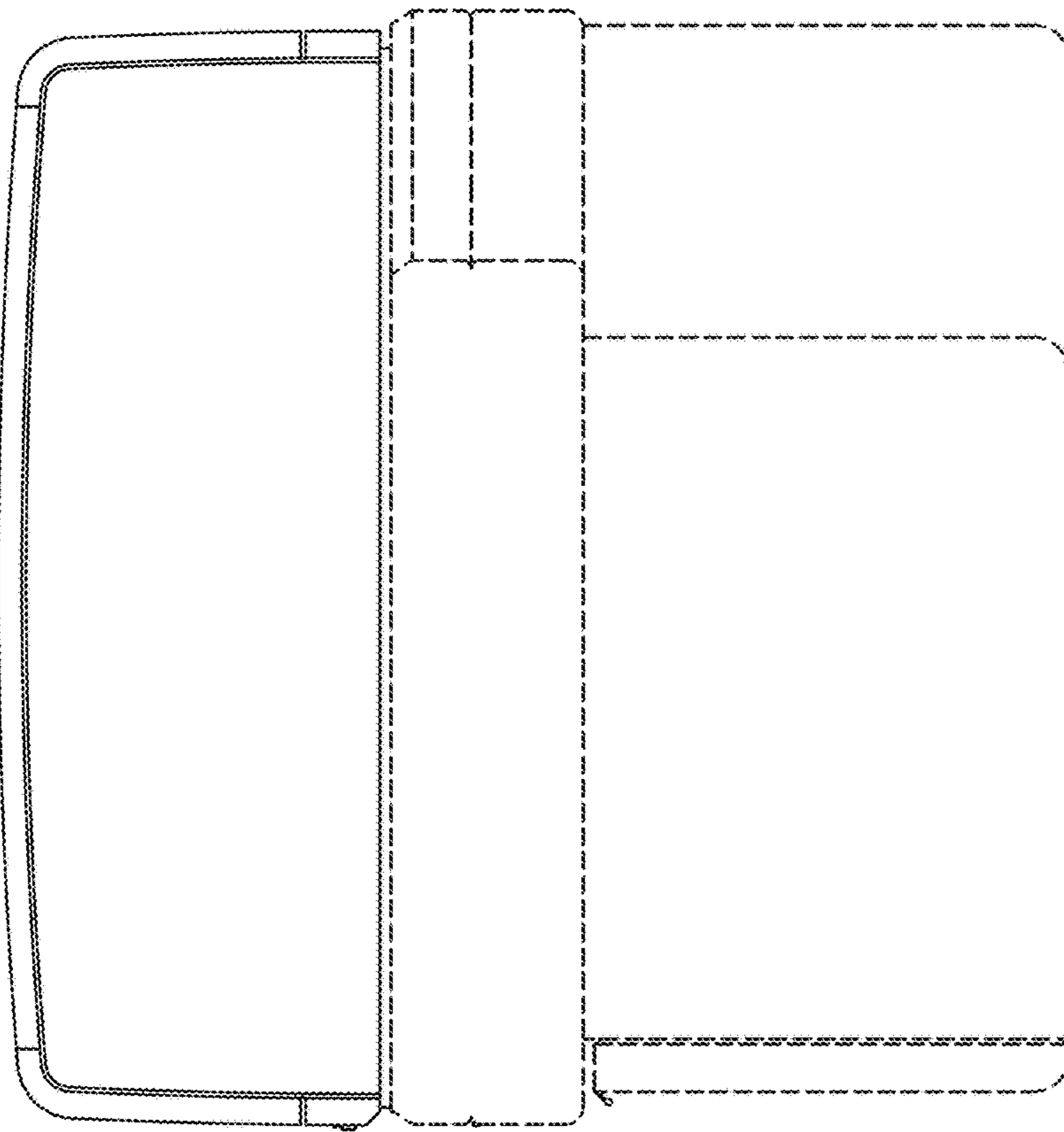


FIG. 6



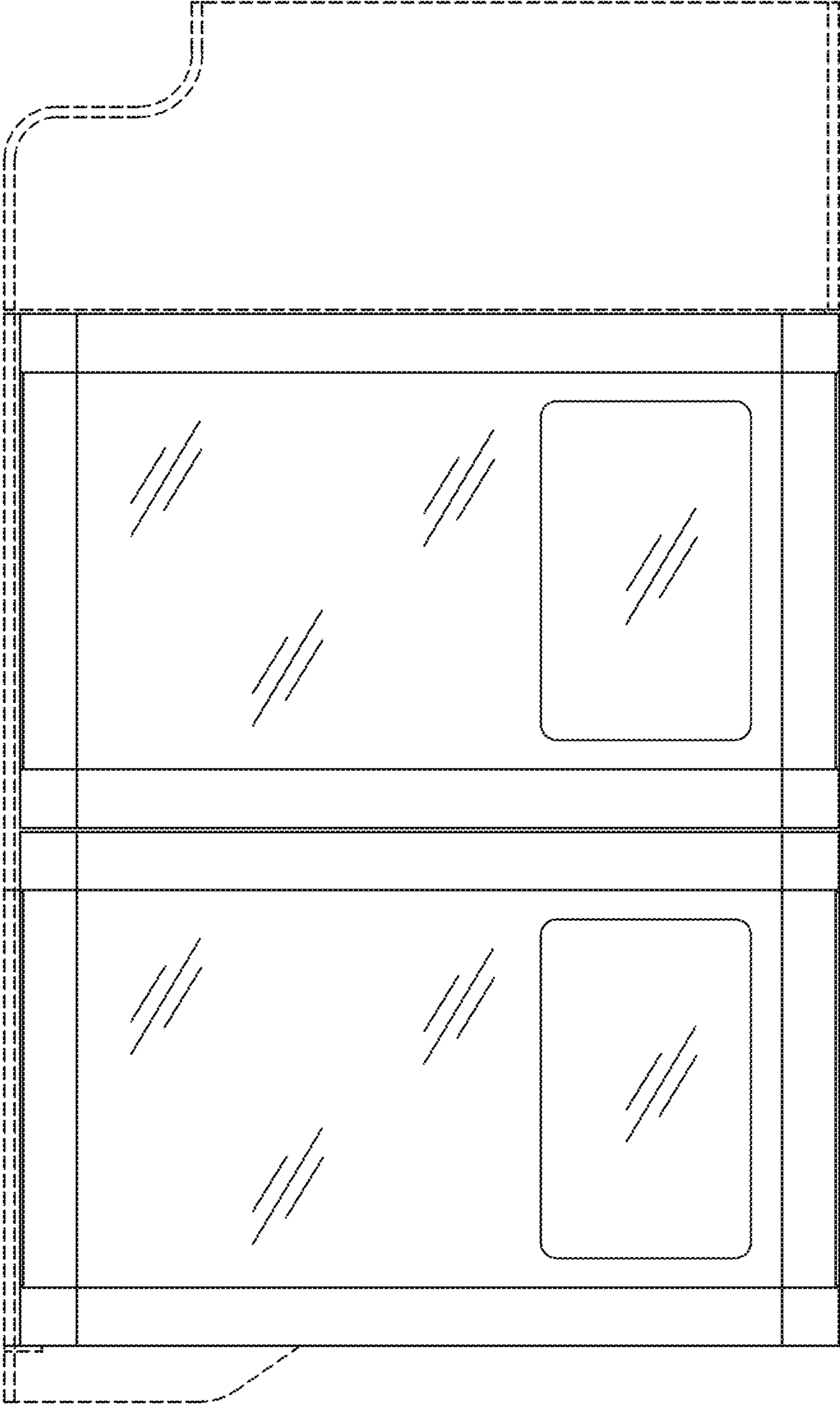


FIG. 7

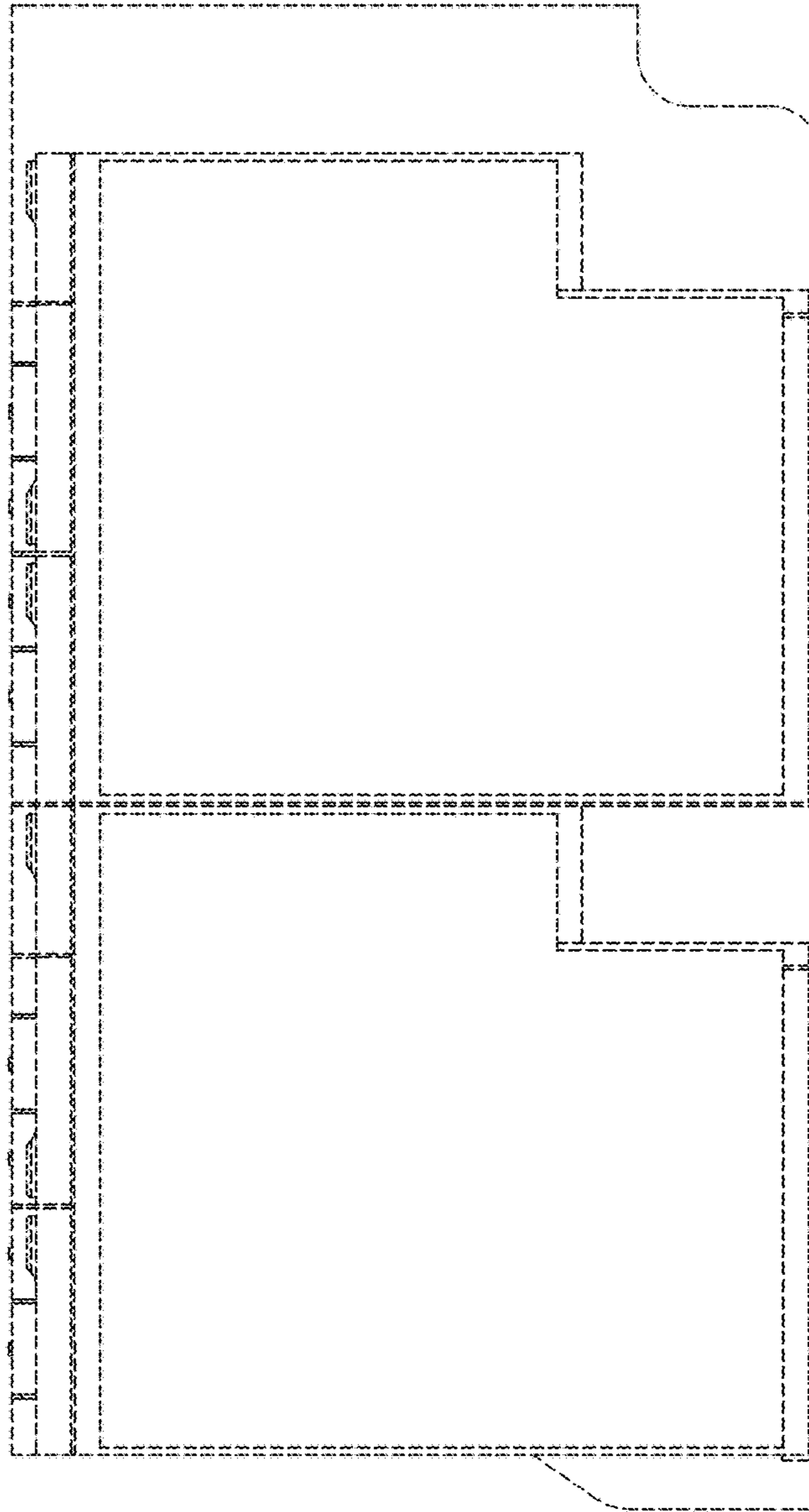


FIG. 8